

August 1995

#### DESCRIPTION

The SSI 32R2200R/01R/02R/03R are BiCMOS monolithic integrated circuits designed for use with two-terminal recording heads. They provide a low noise read amplifier, write current control, and data protection circuitry for up to six channels. The SSI 2200R/01R/02R/03R option provides internal 350Ω damping resistors. Damping resistors are switched in during write mode and switched out during read mode. The SSI 32R2200/01/02/03R option does not provide damping resistors. Power supply fault protection is provided by disabling the write current generator during power sequencing. System write to read recovery time is significantly improved by making the read channel outputs high impedance. The device also offers multiple channel "servo bank write" capability to assist in servo writing operations.

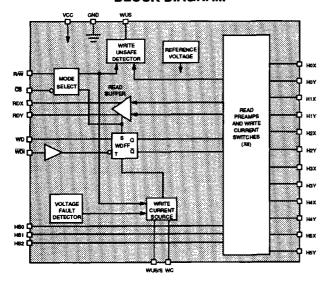
The SSI 32R2200R/01R/02R/03R require only a +5V power supply and are available in a variety of packages. The 32R2201R is hardware compatible with the SSI 32R4610AR and SSI 32R2020R Read/Write devices, while the 32R2202R is the no flip-flop version of the 32R2200R.

#### **FEATURES**

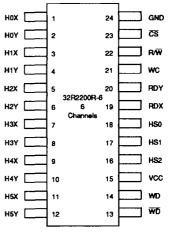
- +5V ± 10% supply
- Low power
  - PD = 105 mW read mode (Nom)
  - PD = 1.0 mW Idle (Max)
- High Performance:
  - Read mode gain = 200 V/V, 250 V/V, 300 V/V, 350 V/V
  - Input noise = 0.5 nV/√Hz (Nom)
  - Input capacitance = 7 pF (Nom)
  - Write current range = 3-35 mA
  - Nominal write current rise/fall time = 7.7 ns (typical head)
  - Head voltage swing = 7.8 Vp-p (Nom)
- Servo bank-write capability
- Self switching damping resistance
- Write unsafe detection

(continued)

#### **BLOCK DIAGRAM**



### **PIN DIAGRAM**



24-Lead SOV, SOL

CAUTION: Use handling procedures necessary for a static sensitive component.

#### FEATURES (continued)

- Power supply fault protection
- Head short to ground protection
- Differential ECL-like (32R2200R/02R/03R) or TTL (32R2201R) write data inputs
- Write data flip/flop (32R2200R/01R/03R) or no flip/ flop 32R2202R

#### **FUNCTIONAL DESCRIPTION**

The SSI 32R2200R/01R/02R/03R has the ability to address up to 6 two-terminal heads and provide write drive or read amplification. Mode control and head selection are described in Tables 1 and 2. The TTL inputs R/W and CS have internal pull-up resistors to prevent an accidental write condition. HS0, HS1 and HS2 have internal pull down resistors. Internal clamp circuitry will protect the IC from a head short to ground condition in any mode.

**TABLE 1: Mode Select** 

ĊŚ	R/W	WUS/SE	Mode
0	0	•	Single Channel Write. See Table 2.
0	0	**	Servo Write.
0	1	Х	Single Channel Read. See Table 2.
1	Х	Х	ldle.

<sup>\*</sup>WUS/SE is a WUS output unless pulled above VCC.

**TABLE 2: Head Select** 

HS2	HS1	HS0	Head
0	0	0	0
0	0	1	1
0	1	0	2
0	1	1	3
1	0	0	4
1	0	1	5

<sup>\*\*</sup>Servo write mode is activated through the WUS pin as described in the servo write mode section.

#### WRITE MODE

Taking both CS and R/W low selects write mode which configures the SSI 32R2200R/01R/02R/03R as a current switch and activates the Write Unsafe (WUS) detector circuitry. On the 32R2200R/03R, head current is toggled between the X and Y side of the selected head on each low to high transition of WD-WD. On the 32R2201R, head current is toggled between the X and Y side of the selected head on each high to low transition of the Write Data Input (WDI). Note that a preceding Read to Write transition or Idle to Write transition initializes the Write Data Flip-Flop to pass write current into the "X" side of the device. In this case. the Y side is higher potential than the X side. On the 32R2202R, head current is toggled between the X and Y side of the selected head on each transition of WDX-WDY. When the potential of WDX is higher than WDY, the potential on the X-side of the head is higher than the Y-side (HNY is sinking current). The magnitude of the write current (0-pk) is given by:

$$lw = Aw \cdot \frac{Vwc}{Rwc} = \frac{K}{Rwc}$$

where Aw is the write current gain.

RWC is connected from pin WC to GND. Note the actual head current lx, y is given by:

$$lx, y = \frac{lw}{1 + Rh/Rd}$$

Where:

Rh = Head resistance plus external wire resistance

Rd = Damping resistance

In write mode a  $350\Omega$  damping resistor is switched in across the Hx, Hy ports (32R2200R/01R/02R/03R only).

#### **SERVO WRITE MODE**

This mode allows for writing to multiple channels at once, which is useful during servo formatting. In this mode the write driver will drive all channels simultaneously.

To enable servo write mode follow these steps:

- (1) Place the device in the read mode (R/W high).
- (2) Set the head select lines to address head 1.

- (3) Pull the WUS output above Vcc by sourcing 10 mA of current into the pin. Two ways to source this current are: (a) use a voltage source set to Vcc +1.9 volts limited to 10 mA of current, or (b) use a resistor tied between WUS and a supply above Vcc to source the current. With 10 mA of current, WUS will rise to approximately Vcc +1.5 volts.
- (4) Allow at least 1 μs setup.
- (5) While maintaining steps (2) and (3) above make R/W low, placing the device in servo write mode.

#### POWER SUPPLY FAULT PROTECTION

A voltage fault detection circuit improves data security by disabling the write current generator during a voltage fault or power startup regardless of mode. Note that WUS does not necessarily turn on to flag a power supply fault condition.

#### **HEAD SHORT TO GROUND PROTECTION**

The SSI 32R2200R/01R/02R/03R provides a head short to ground protection circuit in write mode. If the selected head is shorted to ground the write current generator will turn off, the WUS flag will go high, and current will be limited to less than 1 mA out of the head port. Note that any unselected head is pulled to ground through internal circuitry. In the idle mode, all heads are similarly pulled to ground.

In read mode, current out of the selected head port will not exceed 3 mA if the head is shorted to ground.

#### **WRITE UNSAFE**

Upon entering write mode, WUS is initialized low. Any of the following conditions will be indicated as a high level on the Write Unsafe, WUS, open collector output.

- Write data frequency too low
- Device in read mode
- Device not selected
- No head current
- Open head
- · Head short to ground

To insure no false WUS trigger, the product of head current and head resistance (Iw • Rh) should be less than [0.14 (Iw) - 0.2]V, where Iw is in mA, for Iw range from 3 mA to 10 mA, and less than 1.2V for Iw range from 10 mA to 35 mA. The open head detect circuit is also disabled when write data frequency is above 10 MHz to prevent false WUS detect.

### FUNCTIONAL DESCRIPTION (continued)

Write data frequency too low is detected if the write data frequency falls below 500 kHz. Consult the WUS Safe to Unsafe timing for range of frequency detection.

**Device In read mode, Device In servo write mode** and **Chip disabled** will flag WUS if R/W is high, if servo write mode is activated, or  $\overline{CS}$  is high.

No head current will flag WUS if Rwc =  $\infty$  and the selected head is present.

**Head opened will flag WUS if Rh** =  $\infty$  and the write data frequency is less than 10 MHz.

**Head short to ground** is described in the preceding paragraph.

#### **READ MODE**

The read mode configures the SSI 32R2200R/01R/02R/03R as a low noise differential amplifier and deactivates the write current generator. The damping resistor is switched out of the circuit allowing a high impedance input to the read amplifier. The RDX and RDY outputs are driven by emitter followers and should be AC coupled to the load. The HnX, HnY inputs are non-inverting to the RDX. RDY outputs.

Note that in idle or write mode, the read amplifier is deactivated and RDX, RDY outputs become high impedance. This facilitates multiple R/W applications (wired-OR RDX, RDY) and minimizes voltage change when switching from write to read mode. Note also that the write current source is deactivated for both the read and idle mode.

#### IDLE MODE

Taking  $\overline{CS}$  high selects the idle mode which switches the RDX and RDY outputs into a high impedance state and deactivates the device. Power consumption in this mode is held to a minimum.

# **PIN DESCRIPTION**

### CONTROL/STATUS

NAME	TYPE	DESCRIPTION
CS	_	Chip Select Input. A logical low level enables the device. This pin is an internal pull up.
R/Wt	1	Read/Write. A logical high level enables read mode. A logical low level enables write mode. This pin is an internal pull up.
HS0,HS1, HS2	1	Head Select. Decoded address (internal pull down) selects one of 6 channels. See Table 2.
WUS/SE†	1/0	Write Unsafe/Servo Enable. When in Servo Bank write mode, pulling this pin above Vcc enables servo bank write. See Servo write mode section. Otherwise, a high level indicates an unsafe writing condition. See WUS section.
wct	-	Write Current. A resistor to ground from WC sets the write current through the recording head.

# **HEAD TERMINAL CONNECTIONS**

H0X-H5X		X,Y Head Connections
H0Y-H5Y	ŀ	

### **DATA INPUT/OUTPUT**

WDI† (32R2201R)	ł	Write Data In. A negative transition of WDI changes the direction of current in the recording head.
WD, WD† (32R2200R/03R)	ı	Differential Write Data In. A positive transition of WD-WD changes the direction of current in the recording head.
WDX,WDY (32R2202R)	-	Differential Write Data In. Each transition of WDX-WDY changes the direction of current in the recording.
RDX,RDY†	0	Differential Read Data Out. Emitter follower output.

### **POWER**

VCC	Ι	+5V power supply
GND	1	Ground

<sup>†</sup> When more than one Read/Write device is used, signals can be wire OR'ed.

# **ELECTRICAL SPECIFICATIONS**

Current maximums are currents with the highest absolute value.

### **ABSOLUTE MAXIMUM RATINGS**

Operation beyond the maximum ratings may damage the device.

PARAMETER		RATING		
DC Supply Voltage		VCC	-0.3 to 6 VDC	
Write Current		lw	65 mA	
Digital Input Volt	age	Vin	-0.3 to VCC + 0.3 VDC	
Head Port Voltag	Head Port Voltage VH		-0.3 to VCC + 0.3 VDC	
WUS Pin Voltage	9	Vwus	7.5 VDC	
Output Current	RDX,RDY	lo	-10 mA	
	WUS Iwus		+15 mA	
Junction Operati	Junction Operating Temperature Tj		+125°C	
Storage Temperature		-65 to +150°		

### RECOMMENDED OPERATING CONDITIONS

PARAMETER	CONDITIONS	
DC Supply Voltage	VCC	5 ± 10%V
Ambient Operating Temperature	Та	0°C < Ta < 75°C

### **TEST CONDITIONS**

Recommended operating conditions apply.

PARAMETER	-	CONDITIONS
Write Current, Iw		20 mA
Head Inductance, Lh		1 μΗ
Head Resistance, Rh		30Ω
WD Frequency		5 MHz
WD, WD rise/fall time	32R2200R/02R/03R	1 ns
WDI rise/fall time	32R2201R	1 ns

### **POWER DISSIPATION**

Recommended operating conditions apply.

PARAMETER	CONDITIONS	MIN	МОИ	MAX	UNIT
VCC Supply Current	read mode		21	30	mA
	write mode		42	55	mA
	idle mode		0.04	0.2	mA
Power Dissipation	read mode		105	165	mW
	write mode		210	303	mW
	idle mode		0.2	1	mW

### **DIGITAL INPUTS**

DIGITAL IIII OIO						
Input High Voltage HSX, CS/, R/W, WDI	Vih		2			VDC
Input Low Voltage HSX, CS/, R/W, WDI	Vil				0.8	VDC
Input High Current HSX, CS/, R/W, WDI	lih	Vih = 2.0V			100	μА
Input Low Current HSX, CS/, R/W, WDI	lil	Vil = 0.8V	-0.4			mA
WD, WD Input High Voltage	Vih	32R2200R/02R/03R	Vcc - 1.1		Vcc - 0.4	VDC
WD, WD Input Low Voltage	Vil	32R2200R/02R/03R	Vcc - 2		Vih - 0.25	VDC
WD, WD Input High Current		Vih = Vcc-0.4V (32R2200R/02R/03R)		2	50	μА
WD, WD Input Low Current		Vil = Vcc-1.45V (32R2200R/02R/03R)	-50	0	50	μА
WUS Output Low Voltage	Vol	lol = 2 mA max		0.2	0.5	VDC

# **ELECTRICAL SPECIFICATIONS** (continued)

# WRITE CHARACTERISTICS

Test conditions apply unless otherwise specified.

PARAMETER	CONDITIONS	MIN	NOM	MAX	UNIT
Write Current Range Vwc		3		35	mA
Write Current Voltage Vwc			2		V
Write Current Gain Aw	Iw = Aw•Vwc/Rwc		26		mA/mA
Write Current Constant "K"	lw = K/Rwc	47	52	57	٧
Differential Head Voltage Swing	Open Head, Iw = 20 mA	6.5	7.8		Vp-p
Head Differential Rd	32R2200/01/02/03	2.4	3	3.6	kΩ
Load Resistance	32R2200R/01R/02R/03R	280	350	420	Ω
WD Pulse Width	PWH	5			ns
(see Figure 1)	PWL	5			ns
Unselected Head Voltage			0	0.1	VDC
Unselected Head Current	DC		0	0.2	mA
VCC Fault Voltage	lw ≤ 0.2 mA	3.4	3.8	4.3	V
Head Current HnX,HnY	VCC fault condition	-200		200	μА

# **SERVO WRITE CHARACTERISTICS**

Write Current Range		3		25	mA
Write Current Matching	Between channels		±10%		
WUS/SE Voltage	Servo Bank Write Enabled		Vcc + 1.5	Vcc + 1.9	V
WUS/SE Sink Current	Servo Bank Write Enabled	10			mA

# **READ CHARACTERISTICS**

Test conditions apply unless otherwise specified. CL (RDX, RDY) < 20 pF, RL (RDX, RDY) = 1 k $\Omega$ .

PARAMETER		CONDITIONS	MIN	NOM	MAX	UNIT
Differential Voltage Gain		Vin = 1 mVp-p @1 MHz R2200RX/01RX/02RX/03RX	250	300	350	V/V
		R2201RY	230	350	410	V/V
		R2201RV	165	200	235	V/V
Voltage BW	-1 dB	Zs  < 5Ω, Vin = 1 mVp-p	30 40			MHz
	-3 dB		65	85		MHz
Input Noise Voltage		BW = 15 MHz, Lh = 0, Rh = 0		0.50	0.65	nV/√Hz
Input Noise Current				3.5		pA/√Hz
Differential Input Capacitance		Vin = 1 mVp-p, f = 5 MHz		7.5 12		pF
Differential Input Resistance		Vin = 1 mVp-p, f = 5 MHz	500	850		Ω
Dynamic Range		AC input voltage where gain falls to 90% of its small signal gain value, f = 5 MHz	2	9		mVp-p
Common Mode Rejection Ratio		Vin = 0 VDC + 100 mVp-p @ 5 MHz	50	70		dB
Power Supply Rejection Ratio		100 mVp-p @ 5 MHz on VCC	50	70		dB
Channel Separation		Unselected channels driven with Vin = 0 VDC + 100 mVp-p	50	60		dB
Output Offset Voltage		Lh = 0, Rh = 0	-250		+250	m∨
Single Ended Output Resistance		f = 5 MHz		35	50	Ω
Output Current		AC coupled load, RDX to RDY	2	2.8		mA
RDX, RDY Common Mode Output Voltage				Vcc - 2.5		VDC

# **ELECTRICAL SPECIFICATIONS** (continued)

# **SWITCHING CHARACTERISTICS**

Test conditions apply unless otherwise specified.

PARAMETER		CONDITIONS	MIN	NOM	MAX	UNIT
R/W Read to Write		R/W to 90% of write current		0.06	0.4	μs
	Write to Read	R/W to 90% of 100 mV Read signal envelope		0.1	0.4	μs
CS Unselect to Read		CS to 90% of 100 mV 10 MHz Read signal envelope			0.6	μs
	Write to Unselect	CS to 10% of write current		0.04	0.6	μs
HS0,1 to any Head		To 90% of 100 mV 10 MHz Read signal envelope		0.06	0.6	μs
WUS Safe to Unsafe (TD1)		Write mode, loss of WDI, WD transitions; Defines max WDI, WD period for WUS operation	0.6	2	3.6	μs
Unsafe to Safe (TD2)		Fault cleared: from first negative WDI transition		0.15	0.6	μs
Head Cur	rent WD to Ix - Iy (TD3)	from 50% points Lh = 0, Rh = 0		4	7	ns
Asymmetry		WDI has 1 ns rise/fall time Lh = 0, Rh = 0		0.1	0.5	ns
	Rise/fall Time	10% to 90% points lw = 20 mA, Rh = 0, Lh = 0	_	1	3	ns
		lw = 20 mA, $Rh = 30Ω$ , $Lh = 1$ $μH$		7.7	10	ns

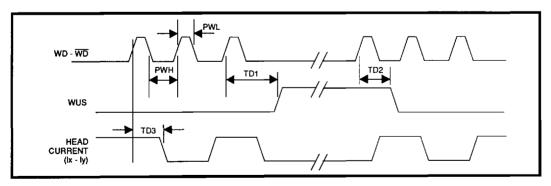


FIGURE 1: 32R2200R/03R Write Mode Timing Diagram

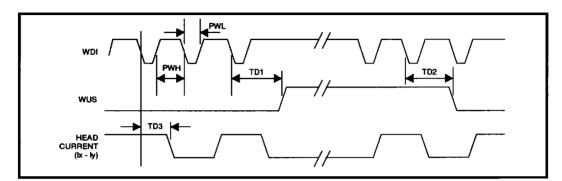


FIGURE 2: 32R2201R Write Mode Timing Diagram

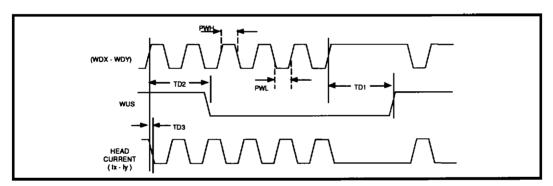
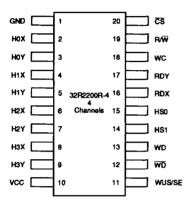
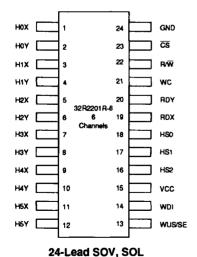


FIGURE 3: 32R2202R Write Mode Timing Diagram

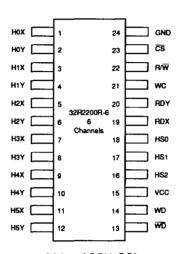
# PACKAGE PIN DESIGNATIONS (Top View)



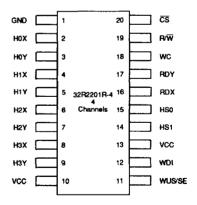
20-Lead SOV, SOL



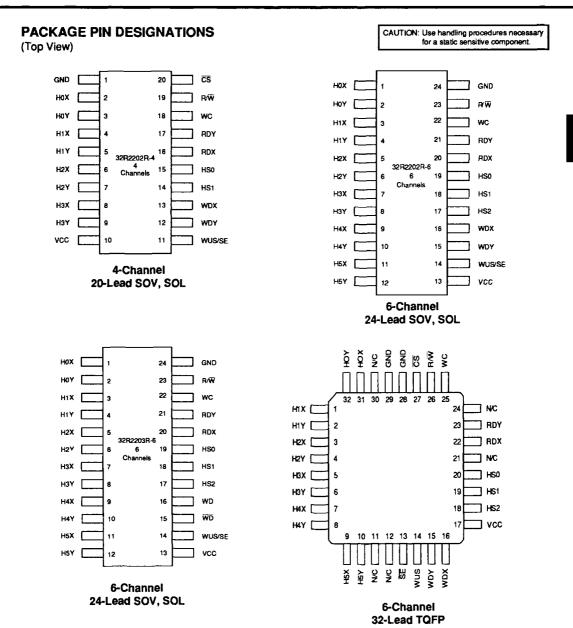
CAUTION: Use handling procedures necessary for a static sensitive component.



24-Lead SOV, SOL



20-Lead SOV, SOL



# **ORDERING INFORMATION**

		PART DESCRIPTION							
PACKAGE MARKING	ORDER NUMBER	PACKAGE			INPUT TYPE		CHIP SELECT	SERVO ENABLE	
SSI 32R2200RX									
32R2200RX-6	32R2200RX-6CV	24-Lead SOV	6	Yes	PECL	300	Yes	No	
32R2200RX-6	32R2200RX-6CL	24-Lead SOL	6						
32R2200RX-4	32R2200RX-4CV	20-Lead SOV	4						
32R2200RX-4	32R2200RX-4CL	20-Lead SOL	4						
SSI 32R2201RX									
32R2201RX-6	32R2201RX-6CV	24-Lead SOV	6	Yes	TTL	300	Yes	Yes	
32R2201RX-6	32R2201RX-6CL	24-Lead SOL	6						
32R2201RX-4	32R2201RX-4CV	20-Lead SOV	4						
32R2201RX-4	32R2201RX-4CL	20-Lead SOL	4						
SSI 32R2201RV									
32R2201RV-6	32R2201RV-6CV	24-Lead SOV	6	Yes	TTL	200	Yes	Yes	
32R2201RV-6	32R2201RV-6CL	24-Lead SOL	6						
32R2201RV-4	32R2201RV-4CV	20-Lead SOV	4						
32R2201RV-4	32R2201RV-4CL	20-Lead SOL	4						
SSI 32R2201RY									
32R2201RY-6	32R2201RY-6CV	24-Lead SOV	6	Yes	TTL	350	Yes	Yes	
32R2201RY-6	32R2201RY-6CL	24-Lead SOL	6						
32R2201RY-4	32R2201RY-4CV	20-Lead SOV	4						
32R2201RY-4	32R2201RY-4CL	20-Lead SOL	4						
SSI 32R2202RX									
32R2202RX-6	32R2202RX-6CGT	32-Lead TQFP	6	No	PECL	300	Yes	Yes	
32R2202RX-6	32R2202RX-6CV	24-Lead SOV	6				No		
32R2202RX-6	32R2202RX-6CL	24-Lead SOL	6				No		
32R2202RX-4	32R2202RX-4CV	20-Lead SOV	4				Yes		
32R2202RX-4	32R2202RX-4CL	20-Lead SOL	4				Yes		
SSI 32R2203RX									
32R2203RX-6	32R2203RX-6CV	24-Lead SOV	6	Yes	PECL	300	No	Yes	
32R2203RX-6	32R2203RX-6CL	24-Lead SOL	6						

<sup>\*</sup>When ordering devices without damping resistors remove the "R" designation. e.g., 32R2200X-6CV

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